

PNP high-voltage transistors

BF470; BF472

FEATURES

- Low feedback capacitance.

APPLICATIONS

- Class-B video output stages in television receivers and for high-voltage IF output stages.

DESCRIPTION

PNP transistors in a TO-126; SOT32 plastic package.
NPN complements: BF469 and BF471.

PINNING

PIN	DESCRIPTION
1	emitter
2	collector, connected to mounting base
3	base

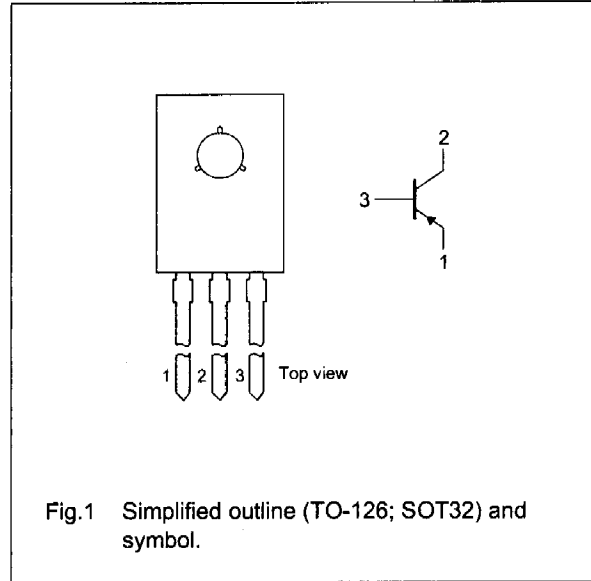
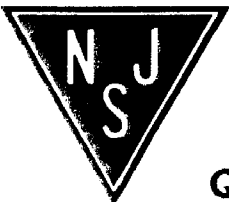


Fig.1 Simplified outline (TO-126; SOT32) and symbol.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BF470		-	-250	V
	BF472		-	-300	V
V _{CEO}	collector-emitter voltage	open base			
	BF470		-	-250	V
	BF472		-	-300	V
I _{CM}	peak collector current		-	-100	mA
P _{tot}	total power dissipation	T _{mb} ≤ 114 °C	-	1.8	W
h _{FE}	DC current gain	I _C = -25 mA; V _{CE} = -20 V	50	-	
C _{re}	feedback capacitance	I _C = I _c = 0; V _{CE} = -30 V; f = 1 MHz	-	1.8	pF
f _T	transition frequency	I _C = -10 mA; V _{CE} = -10 V; f = 100 MHz	60	-	MHz



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Quality Semi-Conductors

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter			
	BF470		-	-250	V
	BF472		-	-300	V
V_{CEO}	collector-emitter voltage	open base			
	BF470		-	-250	V
	BF472		-	-300	V
V_{EBO}	emitter-base voltage	open collector	-	-5	V
I_C	collector current (DC)		-	-50	mA
I_{CM}	peak collector current		-	-100	mA
I_{BM}	peak base current		-	-50	mA
P_{tot}	total power dissipation	$T_{mb} \leq 114\text{ °C}$	-	1.8	W
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		-	150	°C
T_{amb}	operating ambient temperature		-65	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	in free air; note 1	100	K/W
$R_{th\ j-mb}$	thermal resistance from junction to mounting base		20	K/W

Note

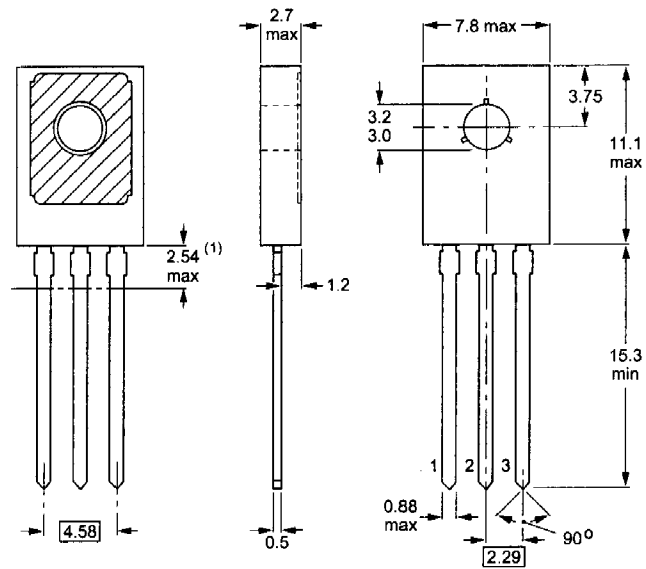
1. Transistor mounted on a printed-circuit board, maximum lead length 4 mm; mounting pad for collector lead minimum 10 × 10 mm.

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -200\text{ V}$	-	-10	nA
		$I_E = 0; V_{CB} = -200\text{ V}; T_j = 150\text{ °C}$	-	-10	μA
I_{EBO}	emitter cut-off current	$I_C = 0; V_{EB} = -5\text{ V}$	-	-50	nA
h_{FE}	DC current gain	$I_C = -25\text{ mA}; V_{CE} = -20\text{ V}$	50	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -30\text{ mA}; I_B = -5\text{ mA}$	-	-600	mV
C_{re}	feedback capacitance	$I_C = I_C = 0; V_{CE} = -30\text{ V}; f = 1\text{ MHz}$	-	1.8	pF
f_T	transition frequency	$I_C = -10\text{ mA}; V_{CE} = -10\text{ V}; f = 100\text{ MHz}$	60	-	MHz

PACKAGE OUTLINE



Dimensions in mm.

(1) Terminal dimensions within this zone are uncontrolled.

Fig.2 TO-126; SOT32.